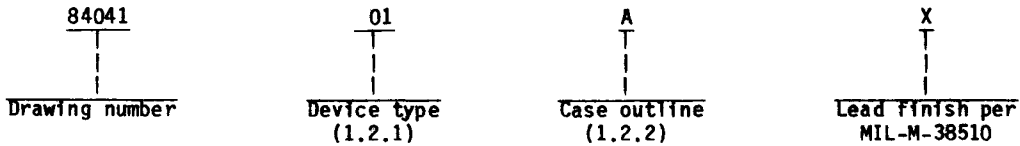


1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device type. The device type shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54HC02	Quad 2-input NOR gate

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
A	F-1 (14-lead, .280" x .260" x .085"), flat package
B	F-3 (14-lead, .280" x .200" x .070"), flat package
C	D-1 (14-lead, .785" x .310" x .200"), dual-in-line package
D	F-2 (14-lead, .390" x .260" x .085"), flat package
2	C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package

1.3 Absolute maximum ratings.

Supply voltage range 1/-	-0.5 V dc to +7.0 V dc
DC input voltage-	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC output voltage -	-0.5 V dc to $V_{CC} + 0.5$ V dc
Clamp diode current -	± 20 mA
DC output current (per pin) -	± 25 mA
DC V_{CC} or GND current (per pin) -	± 50 mA
Storage temperature range -	-65°C to +150°C
Maximum power dissipation, (P_D) 2/ -	500 mW
Lead temperature (soldering, 10 seconds)-	+260°C
Thermal resistance, junction-to-case (θ_{JC})-	See MIL-M-38510, appendix C
Junction temperature (T_J) -	+175°C

1/ Unless otherwise specified all voltages are referenced to ground.
 2/ For $T_C = +100^\circ\text{C}$ to $+125^\circ\text{C}$, derate linearly at 12 mW/ $^\circ\text{C}$.

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1.4 Recommended operating conditions.

Supply voltage (V_{CC}) - - - - -	+2.0 V dc to +6.0 V dc
Case operating temperature range (T_C) - - - - -	-55°C to +125°C
Input rise or fall time:	
$V_{CC} = 2.0$ V - - - - -	0 to 1000 ns
$V_{CC} = 4.5$ V - - - - -	0 to 500 ns
$V_{CC} = 6.0$ V - - - - -	0 to 400 ns

2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth table. The truth table shall be as specified on figure 2.

3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.

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TABLE 1. Electrical performance characteristics.

Test	Symbol	Conditions -55°C < T _c < +125°C, unless otherwise specified 1/		Group A subgroups	Limits		Unit
					Min	Max	
High level output voltage	V _{OH}	V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 20 μA	V _{CC} = 2.0 V	1, 2, 3	1.9		V
			V _{CC} = 4.5 V		4.4		
			V _{CC} = 6.0 V		5.9		
		V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 4.0 mA	V _{CC} = 4.5 V		3.7		
		V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 5.2 mA	V _{CC} = 6.0 V		5.2		
Low level output voltage	V _{OL}	V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 20 μA	V _{CC} = 2.0 V	1, 2, 3		0.1	V
			V _{CC} = 4.5 V		0.1		
			V _{CC} = 6.0 V		0.1		
		V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 4.0 mA	V _{CC} = 4.5 V		0.4		
		V _{IN} = V _{IH} minimum or V _{IL} maximum I _O ≤ 5.2 mA	V _{CC} = 6.0 V		0.4		
High level input voltage	V _{IH}	2/	V _{CC} = 2.0 V	1, 2, 3	1.5		V
			V _{CC} = 4.5 V		3.15		
			V _{CC} = 6.0 V		4.2		
Low level input voltage	V _{IL}	2/	V _{CC} = 2.0 V	1, 2, 3		0.3	V
			V _{CC} = 4.5 V		0.9		
			V _{CC} = 6.0 V		1.2		
Input capacitance	C _{IN}	V _{IN} = 0.0 V See 4.3.1c	T _c = +25°C	4		10	pF
Quiescent current	I _{CC}	V _{CC} = 6.0, V _{IN} = V _{CC} or GND, I _{OUT} = 0		1, 2, 3		40	μA

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T _C < +125°C, unless otherwise specified <u>1/</u>	Group A subgroups	Limits		Unit
				Min	Max	
Input leakage current	I _{IN}	V _{CC} = 6.0, V _{IN} = V _{CC} or GND	1, 2, 3		±1	µA
Functional tests		See 4.3.1d	7			
Propagation delay time, A, B to Y <u>3/</u>	t _{PHL}	T _C = +25°C C _L = 50 pF ±10% See figure 3	9	V _{CC} = 2.0 V	100	ns
				V _{CC} = 4.5 V	20	
				V _{CC} = 6.0 V	17	
	t _{PLH}	T _C = -55°C, +125°C C _L = 50 pF ±10% See figure 3	10, 11	V _{CC} = 2.0 V	150	ns
				V _{CC} = 4.5 V	30	
				V _{CC} = 6.0 V	25	

1/ For a power supply of 5 V ±10% the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used. Power dissipation capacitance (C_{PD}), typically 50 pF, determines the no load dynamic power consumption, P_D = C_{PD} V_{CC}² f + I_{CC} V_{CC}, and the no load dynamic current consumption, I_S = C_{PD} V_{CC} f + I_{CC}.

2/ V_{IH} and V_{IL} tests are not required, and shall be applied as a forcing function for V_{OH} and V_{OL}.

3/ AC testing at V_{CC} = 2.0 V and V_{CC} = 6.0 V shall be guaranteed, if not tested, to the specified limits.

4/ Transition time (t_{THL}), t_{TLH}), if not tested, shall be guaranteed to the specified limits.

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Device type 01

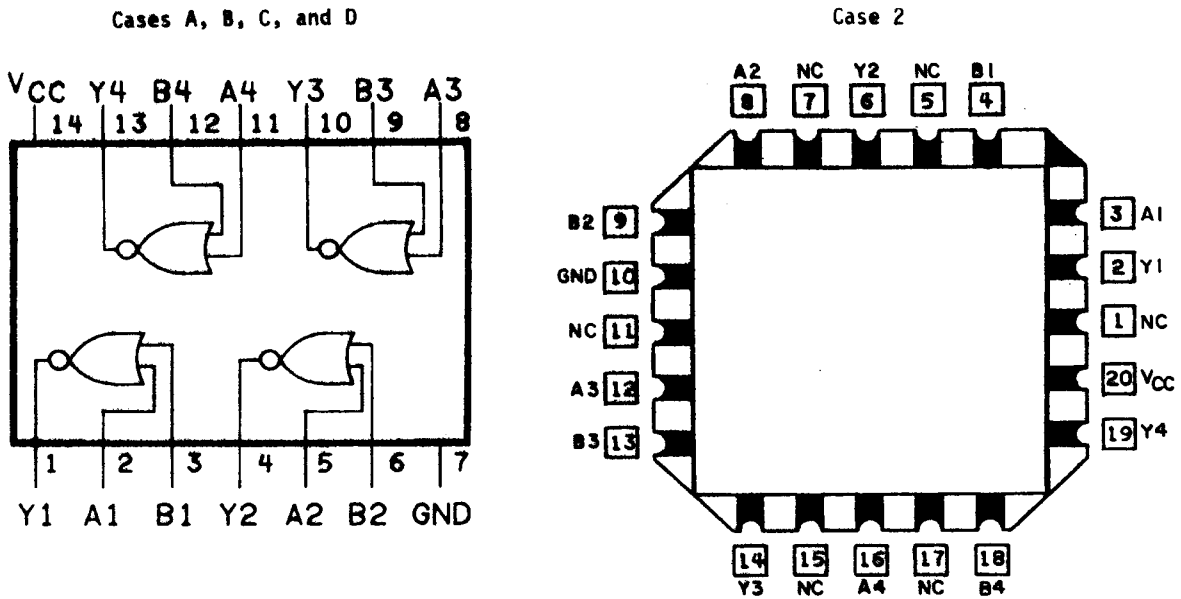


FIGURE 1. Terminal connections (top view).

Device type 01

Truth table each gate

Input		Output
A	B	Y
L	L	H
H	L	L
L	H	L
H	H	L

Positive logic $Y = \overline{A + B}$

FIGURE 2. Truth table.

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Device type 01

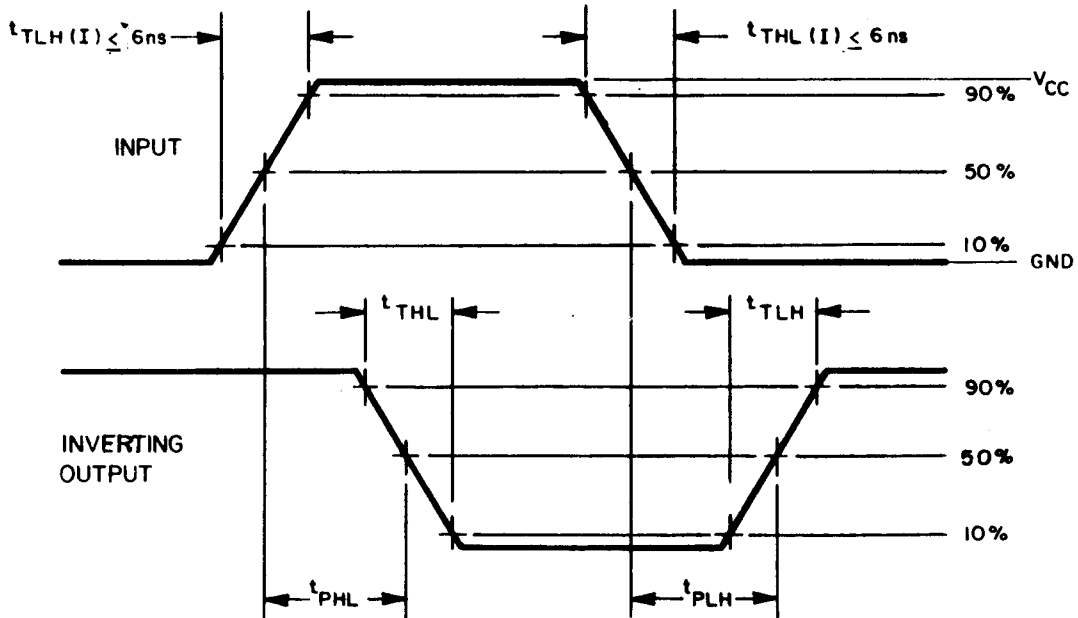


FIGURE 3. Switching waveforms.

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3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C_{IN} measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance. Test all applicable pins on 5 devices with zero failures.
- d. Subgroup 7 tests shall verify the truth table specified on figure 2.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 9
Group A test requirements (method 5005)	1, 2, 3, 4, 7, 9, 10, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

- (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
- (2) $T_A = +125^\circ\text{C}$, minimum.
- (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Replaceability is determined as follows:

- a. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- b. When a QPL source is established, the part numbered device specified in this drawing will be replaced by the microcircuit identified as part number M38510/65101BXX.

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6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor 1/ similar part number	Replacement military specification part number
8404101AX <u>2/</u>		MM54HC02W/883B	M38510/65101BAX
8404101BX <u>2/</u>		SNJ54HC02WA	M38510/65101BBX
8404101CX <u>3/</u>	01295 04713 18714 27014	SNJ54HC02J 54HC02/BCAJC CD54HC02F/3A MM54HC02J/883	M38510/65101BCX
8404101DX	01295 27014	SNJ54HC02W MM54HC02W/883	M38510/65101BDX
84041012X <u>3/</u>	01295 04713 27014	SNJ54HC02FK 54HC02M/B2AJC MM54HC02E/883	M38510/65101B2X

- 1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 2/ Not available from approved source of supply.
- 3/ Inactive for new design. Use M38510/65101B-- device.

Vendor CAGE number	Vendor name and address
01295	Texas Instruments, Incorporated P.O. Box 60448 Midland, TX 79711-0448
04713	Motorola, Incorporated 7402 S. Price Road Tempe, AZ 85283
18714	Harris/RCA Corporation Route 202 Somerville, NJ 08876
27014	National Semiconductor 2900 Semiconductor Drive Santa Clara, CA 95051

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